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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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Silicon PNP Triple Diffused

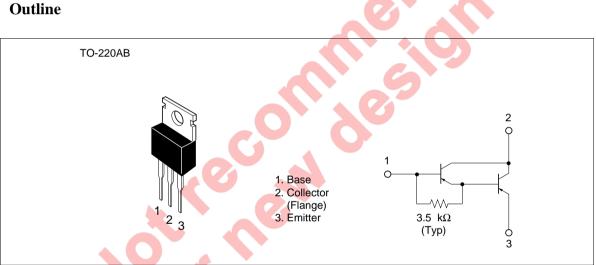
RENESAS

ADE-208-867 (Z) 1st. Edition September 2000

Application

Low frequency power amplifier

Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

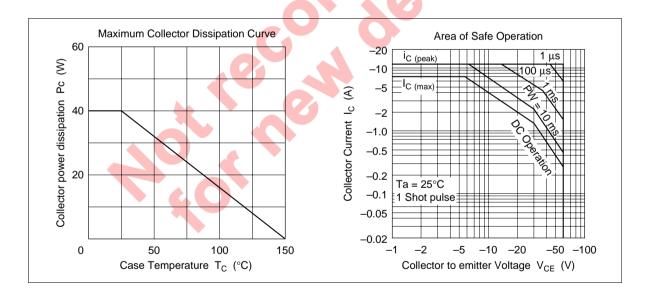
Symbol	Ratings	Unit	
V _{CBO}	-60	V	
V _{CEO}	-60	V	
V _{EBO}	-7	V	
Ι _c	-8	А	
I _{C(peak)}	-12	А	
Pc*1	40	W	
Tj	150	°C	
Tstg	-55 to +150	°C	
	V _{CBO} V _{CEO} V _{EBO} I _C I _{C(peak)} P _C * ¹ Tj	V _{CBO} -60 V_{CEO} -60 V_{CEO} -70 I_c -8 $I_{c(peak)}$ -12 P_c^{*1} 40 Tj 150	

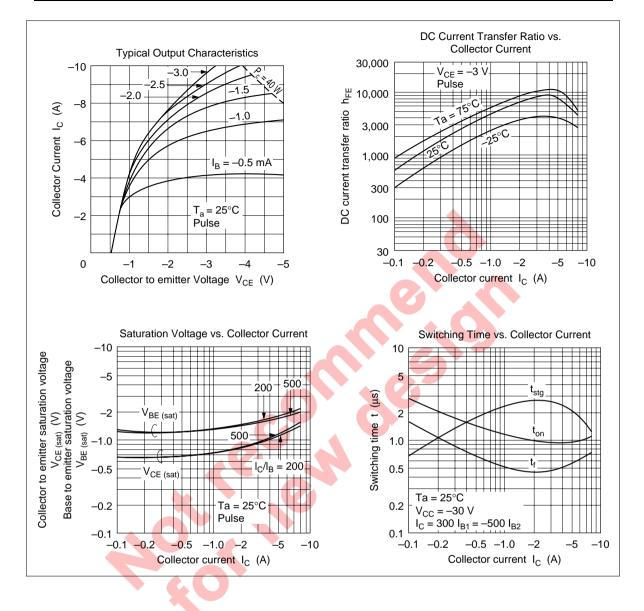
1. Value at $T_c = 25^{\circ}C$. Note:

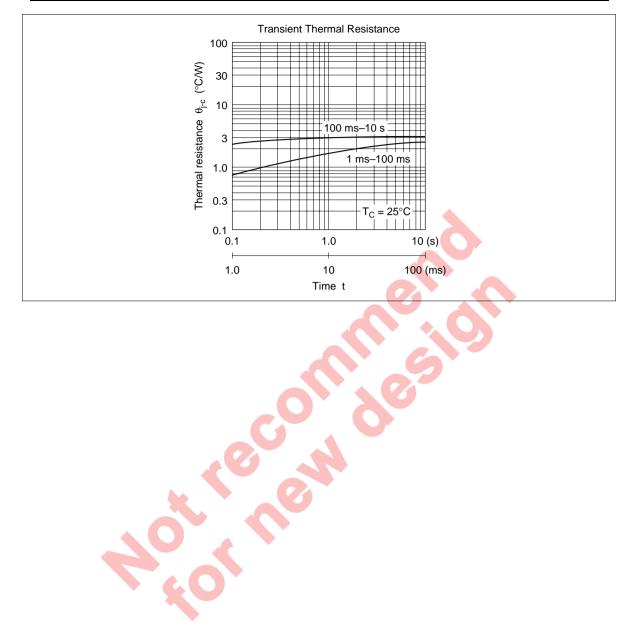
Electrical Characteristics (Ta = 25° C)

Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	-60	_	—	V	$I_c = -25$ mA, $R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	-7	_	—	V	$I_{\rm E} = -50$ mA, $I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_	_	-100	μA	$V_{\rm CB} = -60 \text{ V}, I_{\rm E} = 0$
	I _{CEO}	—	—	-10	μA	$V_{ce} = -50$ V, $R_{be} = \infty$
DC current transfer ratio	h _{FE}	1000	—	20000		$V_{ce} = -3 V, I_c = -4 A^{*1}$
Collector to emitter saturation	$V_{\text{CE(sat)1}}$	—	—	-1.5	V	$I_{c} = -4 \text{ A}, I_{B} = -8 \text{ mA}^{*1}$
voltage	$V_{\text{CE(sat)2}}$	—	—	-3.0	V	$I_{\rm c} = -8$ A, $I_{\rm B} = -80$ mA ^{*1}
Base to emitter saturation	$V_{BE(sat)1}$	—	—	-2.0	V	$I_{c} = -4 \text{ A}, I_{B} = -8 \text{ mA}^{*1}$
voltage	$V_{\text{BE(sat)2}}$	—	—	-3.5	V	$I_{\rm c} = -8$ A, $I_{\rm B} = -80$ mA ^{*1}
Turn on time	t _{on}	—	1.0	-	μs	$I_{\rm c} = -4$ A, $I_{\rm B1} = -I_{\rm B2} = -8$ mA
Storage time	t _{stg}	_	2.5	-	μs	
Fall time	t _f	_	0.5	-	μs	

Note: 1. Pulse Test.







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HITACH

Hitachi, Ltd.

Semiconductor & IC Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

For further information write to:

Hitachi America, Ltd. Semiconductor & IC Div. 2000 Sierra Point Parkway Brisbane, CA. 94005-1835 U S A Tel: 415-589-8300 Fax: 415-583-4207 Hitachi Europe GmbH Electronic Components Group Continental Europe Dornacher Straße 3 D-85622 Feldkirchen München Tel: 089-9 91 80-0 Fax: 089-9 29 30 00 Hitachi Europe Ltd. Electronic Components Div. Northern Europe Headquarters Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA United Kingdom Tel: 0628-585000 Fax: 0628-778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 0104 Tel: 535-2100 Fax: 535-1533

Hitachi Asia (Hong Kong) Ltd. Unit 706, North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon Hong Kong Tel: 27359218 Fax: 27306071

